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Vishay/Siliconix SUM110P08-11L-E3

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SUM110P08-11L

Vishay Siliconix

P-Channel 80 V (D-S) MOSFET

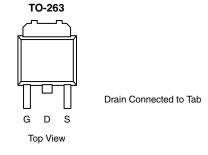
PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^b	Q _g (Typ)			
- 80	0.0112 at V _{GS} = - 10 V	- 110	85 nC			
- 80	0.0145 at V _{GS} = - 4.5 V	- 109	00 110			

FEATURES

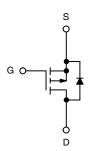
• TrenchFET® Power MOSFET



Material categorization:
 For definitions of compliance please see www.vishay.com/doc?99912



Ordering Information: SUM110P08-11L-E3 (Lead (Pb)-free)



P-Channel MOSFET

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	- 80	V	
Gate-Source Voltage		V _{GS}		± 20
	T _C = 25 °C		- 110 ^a	
Continuous Drain Current /T 175 °C)	T _C = 125 °C		- 71	
Continuous Drain Current (T _J = 175 °C)	T _A = 25 °C	I _D	- 23.5 ^{b, c}	
	T _A = 125 °C		- 13.6 ^{b, c}	
Pulsed Drain Current		I _{DM}	- 120	A .
Ocation of Ocate Projects Ocate	T _C = 25 °C		- 110	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	- 9 ^{b, c}	
Avalanche Current		I _{AS}	- 75	
Single-Pulse Avalanche Energy L = 0.1 mH		E _{AS}	281	mJ
	T _C = 25 °C		375	w
Maximum Power Dissipation	T _C = 125 °C	В .	125	
	T _A = 25 °C	P _D	13.6 ^{b, c}	
	T _A = 125 °C		4.5 ^{b, c}	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	8	11	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	0.33	0.4]	

Notes:

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under steady state conditions is 40 $^{\circ}\text{C/W}.$

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For technical questions, contact: pmostechsupport@vishay.com

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Datasheet of SUM110P08-11L-E3 - MOSFET P-CH 80V 110A D2PAK

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static				•			
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 80			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 1 μA		- 85			
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	η ΙΔ = - Ι μΑ		- 5.5		mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1		- 3	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
7 0		V _{DS} = - 80 V, V _{GS} = 0 V			- 1	μΑ	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -80 V, V _{GS} = 0 V, T _J = 175 °C			- 500		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, V_{GS} = -10 \text{ V}$	- 120			Α	
	В	V _{GS} = - 10 V, I _D = - 20 A		0.0093	0.0112	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 15 A		0.0120	0.0145		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 20 A		85		S	
Dynamic ^b	•			!			
Input Capacitance	C _{iss}			10850			
Output Capacitance	C _{oss}	V _{DS} = - 40 V, V _{GS} = 0 V, f = 1 MHz		800		pF	
Reverse Transfer Capacitance	C_{rss}			700			
Total Gate Charge	Qg	V _{DS} = - 40 V, V _{GS} = - 10 V, I _D = - 110 A		180	270	nC	
				85	130		
Gate-Source Charge	Q _{gs}	$V_{DS} = -40 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -110 \text{ A}$		35			
Gate-Drain Charge	Q_{gd}			42			
Gate Resistance	R_{g}	f = 1 MHz		3.6		Ω	
Turn-On Delay Time	t _{d(on)}			20	30		
Rise Time	t _r	$V_{DD} = -40 \text{ V}, R_{L} = 0.36 \Omega$		330	500		
Turn-Off Delay Time	t _{d(off)}	$I_{D} \cong -110 \text{ A}, V_{GEN} = -10 \text{ V}, R_{g} = 1 \Omega$		135	205	- ns	
Fall Time	t _f			550	825		
Drain-Source Body Diode Characteristic	s			•	l		
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			- 110	Α	
Pulse Diode Forward Current ^a	I _{SM}				- 120		
Body Diode Voltage	V_{SD}	I _S = - 20 A		- 0.8	- 1.5	V	
Body Diode Reverse Recovery Time	t _{rr}			65	100	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	1 00 A di/dt 100 A/:- T 05 00		135	205	nC	
Reverse Recovery Fall Time	t _a	$I_F = -20 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		43		1	
Reverse Recovery Rise Time	t _b	7		22		ns	

Notes:

- a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

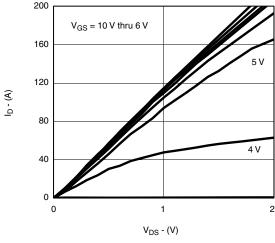


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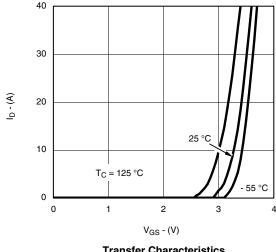
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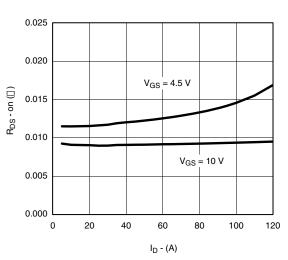
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



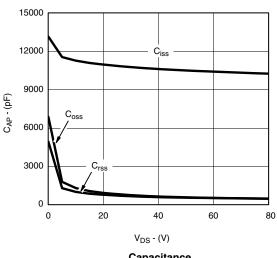
Output Characteristics



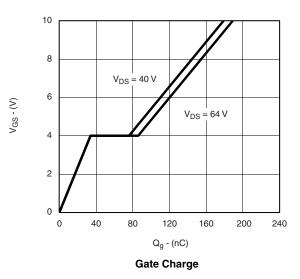
Transfer Characteristics

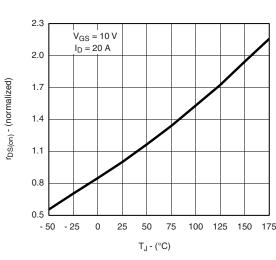


On-Resistance vs. Drain Current



Capacitance





On-Resistance vs. Junction Temperature

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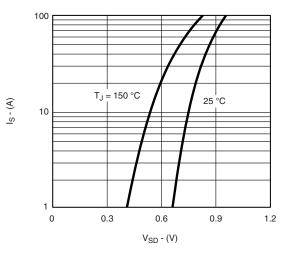
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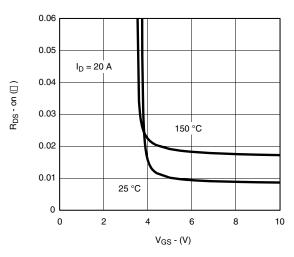
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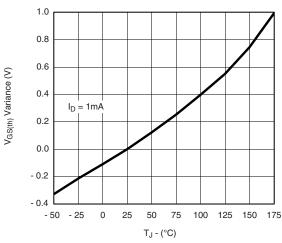
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



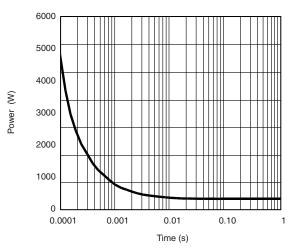
Source-Drain Diode Forward Voltage



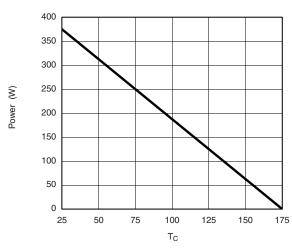
On-Resistance vs. Gate-to-Source Voltage



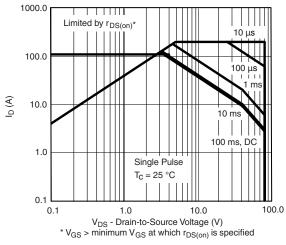
Threshold Voltage



Single Pulse Power, Junction-to-Case (T_C = 25 °C)



Power Derating, Junction-to-Case



Safe Operating Area

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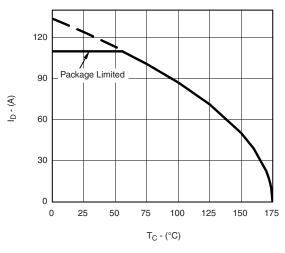
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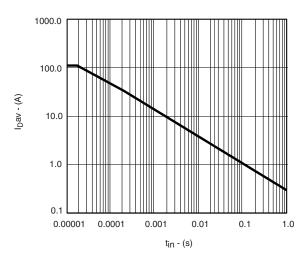


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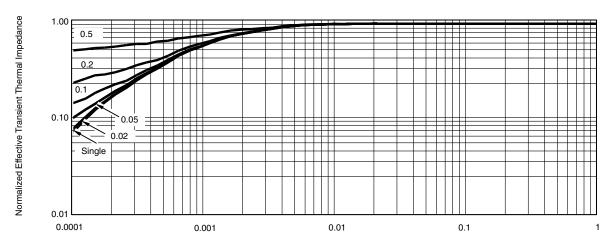
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





Max. Avalanche and Drain Current vs. Case Temperature

Avalanche Current vs. Time



Normalized Thermal Transient Impedance, Junction-to-Case

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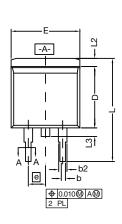
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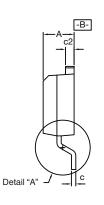


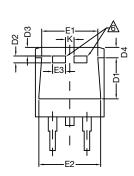
Package Information

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TO-263 (D²PAK): 3-LEAD

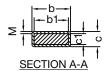








DETAIL A (ROTATED 90°)



Notes 1. Plane B includes maximum features of heat sink tab and plastic. 2. No more than 25 % of L1 can fall above seating plane by

- max. 8 mils.
 3. Pin-to-pin coplanarity max. 4 mils.
- 4. *: Thin lead is for SUB, SYB.
 Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

6. This feature is for thick lead.

		INC	HES	MILLIMETERS		
DIM.		MIN.	MAX.	MIN.	MAX.	
А		0.160	0.190	4.064	4.826	
	b	0.020	0.039	0.508	0.990	
	b1	0.020	0.035	0.508	0.889	
b2		0.045	0.055	1.143	1.397	
c*	Thin lead	0.013	0.018	0.330	0.457	
	Thick lead	0.023	0.028	0.584	0.711	
c1	Thin lead	0.013	0.017	0.330	0.431	
CI	Thick lead	0.023	0.027	0.584	0.685	
	c2	0.045	0.055	1.143	1.397	
D		0.340	0.380	8.636	9.652	
	D1	0.220	0.240	5.588	6.096	
	D2	0.038	0.042	0.965	1.067	
D3		0.045	0.055	1.143	1.397	
	D4	0.044	0.052	1.118	1.321	
Е		0.380	0.410	9.652	10.414	
E1		0.245	-	6.223	-	
E2		0.355	0.375	9.017	9.525	
E3		0.072	0.078	1.829	1.981	
е		0.100 BSC		2.54 BSC		
K		0.045	0.055	1.143	1.397	
L		0.575	0.625	14.605	15.875	
L1		0.090	0.110	2.286	2.794	
L2		0.040	0.055	1.016	1.397	
L3		0.050	0.070	1.270	1.778	
L4		0.010) BSC	0.254 BSC		
	М	-	0.002	-	0.050	
ECN: T13-0707-Rev. K, 30-Sep-13						

ECN: T13-0707-Rev. K, 30-Sep-13

DWG: 5843

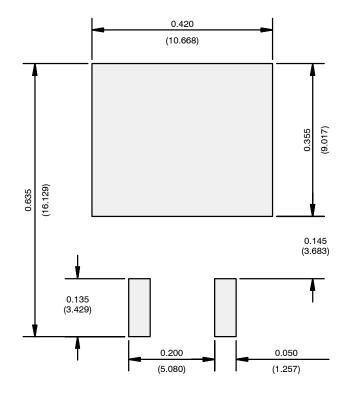
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AN826 Vishay Siliconix

RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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